TOSHIBA PHOTOCOUPLER PHOTO RELAY

TLP3116

MEASUREMENT INSTRUMENTS LOGIC IC TESTERS / MEMORY TESTERS BOARD TESTERS / SCANNERS

The TOSHIBA TLP3116 Mini-flat photorelay is a small-outline photorelay, suitable for surface-mount assembly. The TLP3116 consists of a GaAs infrared-emitting diode optically coupled to a photo-MOS FET and housed in a 4-pin package.

Its characteristics also include low OFF-state current and low output pin capacitance, enabling it to be used in high-frequency measuring instruments.

FEATURES

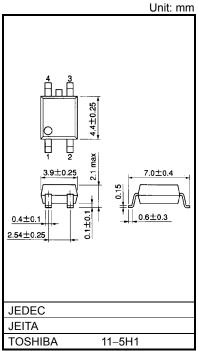
• 4 pin SOP (2.54SOP4) : 2.1 mm high, 2.54 mm pitch

• 1-Form-A

Peak Off-State Voltage : 40 V (MIN.)
 Trigger LED Current : 4 mA (MAX.)
 On-State Current : 120 mA (MAX.)

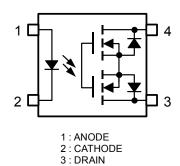
On-State Resistance
 15 Ω (MAX.), 10 Ω (TYP.)
 Output Capacitance
 2.0 pF (MAX.), 1.0 pF (TYP.)

• Isolation Voltage : 1500 Vrms (MIN.)

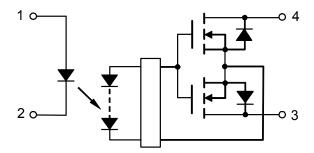


Weight: 0.1 g

PIN CONFIGURATION (TOP VIEW)



SCHEMATIC



MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT
	Forward Current	I _F	50	mA
ED	Forward Current Derating (Ta ≥ 25°C)	ΔI _F /°C	-0.5	mA/°C
۳	Reverse Voltage	V_{R}	5	V
	Junction Temperature	Tj	125	°C
2	Off-State Output Terminal Voltage	V _{OFF}	40	V
DETECTOR	On-State Current	I _{ON}	120	mA
	On-State Current Derating (Ta ≥ 25°C)	Δl _{ON} /°C	-1.2	mA/°C
	Junction Temperature	Tj	125	°C
Storage Temperature Range		T _{stg}	-40~125	°C
Operating Temperature Range		T _{opr}	-20~85	°C
Lead Soldering Temperature (10 s)		T _{sol}	260	°C
Isolat	ion Voltage (AC, 1 minute, R.H. \leq 60%) (NOTE1)	BVS	1500	Vrms

(NOTE1): Device considered a two-terminal device: Pins 1 and, 2 shorted together, and pins 3 and 4 shorted together.

CAUTION

This device is sensitive to electrostatic discharge. When using this device, please ensure that all tools and equipment are earthed.

RECOMMENDED OPERATING CONDITIONS

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply Voltage	V_{DD}	_	_	32	V
Forward Current	I _F	10	_	30	mA
On-State Current	I _{ON}	_	_	120	mA
Operating Temperature	T _{opr}	25	_	60	°C

INDIVIDUAL ELECTRICAL CHARACTERISTICS (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
	Forward Voltage	V _F	I _F = 10 mA	1.0	1.15	1.3	V
LED	Reverse Current	I _R	V _R = 5 V		_	10	μΑ
	Capacitance	C _T	V = 0, $f = 1$ MHz		15		pF
DETECTOR	Off-State Current	I _{OFF}	V _{OFF} = 30 V, Ta = 50°C		_	1000	pА
DETE(Capacitance	C _{OFF}	V = 0, f = 100 MHz, t < 1 s		1.0	2.0	pF

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COUPLED ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Trigger LED Current	I _{FT}	I _{ON} = 100 mA	_		4	mA
Return LED Current	I _{FC}	$I_{OFF} = 10 \mu A$	0.2	0.75	_	mA
On-State Resistance	R _{ON}	$I_{ON} = 120 \text{ mA}, I_F = 5 \text{ mA}, t < 1 \text{ s}$	_	10	15	Ω

ISOLATION CHARACTERISTICS (Ta = 25°C)

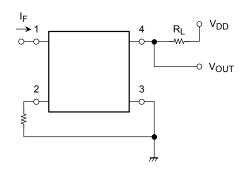
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Capacitance Input to Output	Cs	V _S = 0 V, f = 1 MHz	_	8.0	_	pF
Isolation Resistance	R _S	V _S = 500 V, R.H. ≦ 60%	5 × 10 ¹⁰	10 ¹⁴	_	Ω
		AC, 1 minute	1500	_	_	Vrms
Isolation Voltage	BV_S	AC, 1 second (in oil)	_	3000	_	VIIIIS
		DC, 1 minute (in oil)	_	3000	_	Vdc

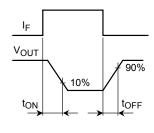
SWITCHING CHARACTERISTICS (Ta = 25°C)

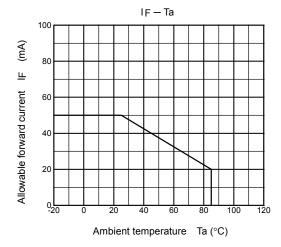
CHARACTERISTIC	SYMBOL	TEST CONDITION		MIN.	TYP.	MAX.	UNIT
Turn-on Time	t _{ON}	$R_L = 200 \Omega$	(NOTE 2)	_	_	500	μS
Turn-off Time	toff	$V_{DD} = 10 \text{ V}, I_F = 10 \text{ mA}$		_		500	μο

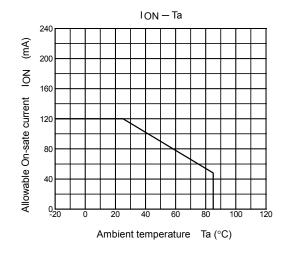
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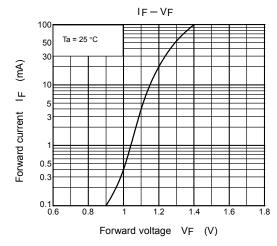
(NOTE 2): SWITCHING TIME TEST CIRCUIT

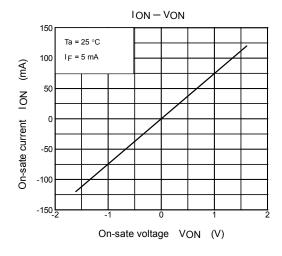


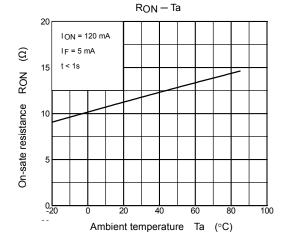


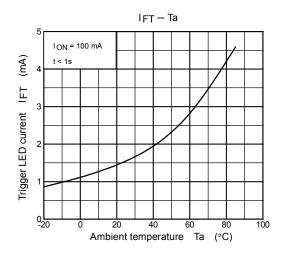


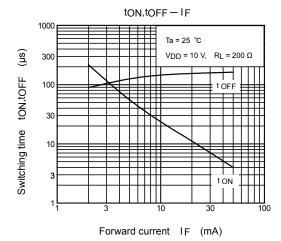


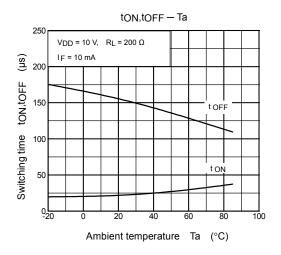


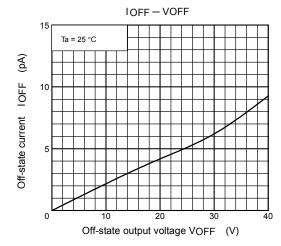


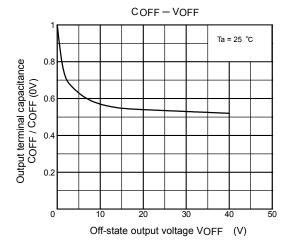












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